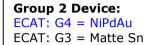
PCN Number:			20200203004.1B					P	CN Date:	Sept. 14, 2020			
Title: Qualification			of TI Clark as an Alternate Assembly Site for Select Package Devices										
Cust	ome	r Conta	ct:	PCN Manager Quality Services									
	_	Гуре:											
		mbly Site						Design				Wafer Bump Site	
		mbly Pro				Data Sh					Щ	Wafer Bump Material	
		mbly Ma							nber change		<u> </u>		mp Process
		anical S				Test Sit				<u> </u>	Wafer Fab Site		
	Раскі	ng/Ship	ping/L	abe	ling			Test Pro	cess		<u>H</u>	Wafer Fab Materials	
								DCN	Details			Wafer Fal	o Process
Doc	crinti	on of C	hang	0'				PCN	Details				
Des	cripti	on or C	nang	e:									
Revision B is to remove select devices in the Prohighlighted in yellow. These devices were inadverted. Texas Instruments is pleased to announce the quasite for select package devices. Material differences are selected. Group 1 Device: UTAC					ualification ces as for the transfer of transfer of the transfer of tr	<mark>dded and i</mark> n of TI Cla	not	affected by	nate Assembly lark 123				
Lead finish		nish		NiPd <i>A</i>		AuAg NiPdA		PdAu		NiPo	dAu		
Grou	ир 2 I	Device <u>:</u>					ı			T			_
		_					UTAC					lark	
		<u> </u>	Mold Com				CZ0351			4222198		_	
			Le	ead finish				Matte Sn			VIP(NiPdAu	
Reason for Change:													
Continuity of Supply													
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):													
None													
Anti	Anticipated impact on Material Declaration												
No Impact to the Material Declaration				Material Declarations or Product Content reports are driven from production data and will be available following the production release. Upon production release the revised reports can be obtained at the site link below http://www.ti.com/quality/docs/materialcontentsearch.tsp									
Cha	nges	to prod	luct i	dent	tifica	tior	re	esulting	from thi	s PCN:			

Assembly Site		
UTAC	Assembly Site Origin (22L)	ASO: NSE
TI Chengdu	Assembly Site Origin (22L)	ASO: CDA
TI Clark	Assembly Site Origin (22L)	ASO: QAB

Sample product shipping label (not actual product label)





(1) (3) (4) (2) (2) (2)

(1P) \$N74L\$07N\$R

(Q) 2000 (D) 0336

(31T)LOT: 3959047MLA

(4W) TKY(1T) 7523483812

(P)

(2P) REV: (V) 0033317

(20L) CSO: SHE (21L) CCO:USA

(22L) ASO: MLA (23L) ACO: MYS

Product Affected : Group 1

FRE014RGZR FRE014RHBR

Product Affected: Group 2

CSD59947QVM	CSD59987QVM	CSD95492QVMT	CSD95496QVM
CSD59957QVM	CSD59988QVM	CSD95495QVM	CSD95496QVMT
CSD59958QVM	CSD95492QVM	CSD95495QVMT	-

Group 1: Qualification Data

Approved on 02/03/2020

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: FRE014	QBS Package Reference: CC26X0RGZ	QBS Package Reference: 430FR5969IRGZR
HTSL	High Temp. Storage Bake, 150C	1000 Hours	-	3/231/0	3/229/0
TC	Temperature Cycle, -65/150C	500 Cycles	-	-	3/231/0
TC	Temperature Cycle, -55/125C	700 Cycles	-	3/231/0	-
HAST	Biased HAST, 130C/85%RH	96 Hours	-	-	3/231/0
ТНВ	THB Biased Temperature and Humidity, 85C/85%RH		-	3/78/0	-
AC	Autoclave 121C	96 Hours	-	-	3/231/0
UHAST Unbiased HAST, 110C/85%RH		264 Hours	-	3/231/0	-
WBP	Bond Pull	Wires	-	3/228/0	3/228/0
WBS Ball Bond Shear		Wires	-	3/228/0	3/228/0

QBS: Qualification By Similarity

Qualification Device FRE014 is qualified at Moisture Sensitivity LEVEL3-260C.

Preconditioning was performed for Unbiased HAST, THB, Temperature Cycle, and HTSL.

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

Group 2: Qualification Data

Approved on 02/27/2020

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: CSD95495QVM	QBS Product Reference: CSD95495QVM	QBS Product Reference: CSD95495QVM	QBS Package Reference: CSD95480RWJ
AC	Autoclave 121C	96 Hours		3/231/0		-
ED	Electrical Characterization	Per Datasheet Parameters	Pass	-	Pass	Pass
HAST	Biased HAST, 110C/85%RH	264 Hours				3/231/0
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	3/231/0		-
HBM	ESD - HBM	2500 V		1/3/0	1/3/0	-
CDM	ESD - CDM	1500 V	1/3/0	1/3/0	1/3/0	-
HTOL	Life Test, 125C	1000 Hr				-
HTSL	High Temp Storage Bake 150C	1000 Hours		3/231/0		3/231/0
LU	Latch-up	Per JESD74		1/6/0	1/6/0	-
TC	Temperature Cycle, - 55/125C	700 Cycles	3/231/0	3/231/0		3/231/0
UHAST	Unbiased HAST, 130C/85%RH	96 Hours	3/231/0			3/231/0

- QBS: Qual By Similarity
- Qual Device CSD95495QVM is qualified at LEVEL2-260C
- Device CSD95495QVM contains multiple dies.
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

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